

# REPORT DOCUMENTATION PAGE

AFRL-SR-AR-TR-03-

Public reporting burden for this collection of information is estimated to average 1 hour per response, including the time for reviewing this collection of information. Send comments regarding this burden estimate or this burden to Department of Defense, Washington Headquarters Services, Directorate for Information Operations and Reports 4302. Respondents should be aware that notwithstanding any other provision of law, no person shall be subject to any penalty for failing to comply with a collection of information if it does not have a valid OMB control number. PLEASE DO NOT RETURN YOUR FORM TO THE ABOVE ADDRESS.

maintaining the  
for reducing  
VA 22202-  
lay a currently

0241

|   |                         |                                       |                                   |  |  |
|---|-------------------------|---------------------------------------|-----------------------------------|--|--|
| <b>1. REPORT DATE (DD-MM-YYYY)</b><br>11-04-2003  |                         | <b>2. REPORT TYPE</b><br>Final Report |                                   | <b>3. DATES COVERED (From - To)</b><br>2001-2002 |  |
| <b>4. TITLE AND SUBTITLE</b><br><br>Reaction Ion Etcher for MEMS Fabrication  |                         |                                       |                                   | <b>5a. CONTRACT NUMBER</b><br>F49620-01-1-0525   |  |
|   |                         |                                       |                                   | <b>5b. GRANT NUMBER</b>                          |  |
|   |                         |                                       |                                   | <b>5c. PROGRAM ELEMENT NUMBER</b><br>62228D      |  |
|   |                         |                                       |                                   | <b>5d. PROJECT NUMBER</b><br>4276                |  |
| <b>6. AUTHOR(S)</b><br><br>W. Kinzy Jones   |                         |                                       |                                   | <b>5e. TASK NUMBER</b><br>AS                     |  |
|   |                         |                                       |                                   | <b>5f. WORK UNIT NUMBER</b>                      |  |
|   |                         |                                       |                                   | <b>8. PERFORMING ORGANIZATION REPORT NUMBER</b>  |  |
| <b>7. PERFORMING ORGANIZATION NAME(S) AND ADDRESS(ES)</b><br><br>Florida International University   |                         |                                       |                                   | <b>10. SPONSOR/MONITOR'S ACRONYM(S)</b>          |  |
| <b>9. SPONSORING / MONITORING AGENCY NAME(S) AND ADDRESS(ES)</b><br>AFOSR<br>4015 Wilson Blvd., Room 713<br>Arlington, VA 22203-1954  |                         |                                       |                                   | <b>11. SPONSOR/MONITOR'S REPORT NUMBER(S)</b>    |  |
|   |                         |                                       |                                   |  |  |
| <b>12. DISTRIBUTION / AVAILABILITY STATEMENT</b><br><br>Approved for Public Release; Distribution Unlimited.  |                         |                                       |                                   |  |  |
| <b>13. SUPPLEMENTARY NOTES</b>  |                         |                                       |                                   |  |  |
| <b>14. ABSTRACT</b><br>This grant was for the purchase and installation of a Reaction Ion Etcher. The grant had a value of \$100,000 and \$93,600 was used to purchase a Model CS1701 Reaction Ion Etcher, single chamber system with capabilities for four reaction gases. Additionally, approximately \$2,400 was spent on the purchase of regulators, gases, and other hardware necessary to make the RIE operational. A small amount of money was used to pay summer support for a graduate student to install and baseline the operation of the RIE. The RIE is fully functional and is a key piece of instrumentation the developing nano/micro electro mechanical systems laboratory, which has recently been augmented by the donation from Motorola, Plantation, FL, of their complete MEMS facility, including an additional March RIE with metal etch capabilities, an OAI micro aligner, a class 100 clean room, an e-beam nanolithography system, and all other support equipment necessary to fabricate N/MEMS. |                         |                                       |                                   |  |  |
| <b>15. SUBJECT TERMS</b>  |                         |                                       |                                   |  |  |
| <b>16. SECURITY CLASSIFICATION OF:</b>  |                         |                                       | <b>17. LIMITATION OF ABSTRACT</b> | <b>18. NUMBER OF PAGES</b>                       | <b>19a. NAME OF RESPONSIBLE PERSON</b>           |
| <b>a. REPORT</b><br>U   | <b>b. ABSTRACT</b><br>U | <b>c. THIS PAGE</b><br>U              | UU                                | 1  | <b>19b. TELEPHONE NUMBER (include area code)</b> |

20030731 099

Standard Form 298 (Rev. 8-98)  
Prescribed by ANSI Std. Z39.18

BEST AVAILABLE COPY

**Final Report**

**"Reaction Ion Etcher for MEMS Fabrication"**

**Grant No. F49620-01-1-0525**

**Submitted by**

**W. Kinzy Jones, Professor  
Mechanical and Materials Engineering  
Florida International University**

**Submitted To**

**Army Research Office  
Department of Defense  
Jenny Haire, Point of Contact  
4300 South Miami Blvd.  
Durham, NC 27703-9142**

**BEST AVAILABLE COPY**

### **From the Proposal Abstract**

The addition of an RIE will complete the required equipment to perform research in MEMS and nanotechnology. FIU possess the fabrication capabilities for a traditional silicon processing facility in the Future Aerospace Science and Technology (FAST) Center (an Air Force funded Center in superconducting microwave technology), the capability of fabricating meso-scale MEMS type devices from co-fire ceramic and assembling MEMS in the Electronics Packaging Laboratory and optical and device sensors applications in the Biomedical Research Institute. This addition will bring our fabrication and educational capabilities into the rapidly expanding area of nanofabrication and devices.

### **Results of the Grant**

This grant was for the purchase and installation of a Reaction Ion Etcher. The grant had a value of \$100,000 and \$93,600 was used to purchase a Model CS1701 Reaction Ion Etcher, single chamber system with capabilities for four reaction gases. Additionally, approximately \$2,400 was spent on the purchase of regulators, gases, and other hardware necessary to make the RIE operational. A small amount of money (approximately \$4,000) was used to pay summer support for a graduate student to install and baseline the operation of the RIE. The RIE is fully functional and is a key piece of instrumentation in the developing nano/micro electro mechanical systems laboratory, which has recently been augmented by the donation from Motorola, Plantation, FL, of their complete MEMS facility, including an additional Marsh RIE with metal etch capabilities, an OAI micro aligner, a class 100 clean room, an e-beam nanolithography system, and all other support equipment necessary to fabricate N/MEMS devices. It should be noted that the grant for the RIE was the impetus for the donation, as Motorola was contacted to provide information on a suggested RIE and they recommended the Marsh system, which FIU bought. This began a working relationship that culminated in the donation of the equipment when the Motorola Plantation facility reorganized their research thrust and decided to consolidate MEMS efforts to other facilities, making their facility able to be donated.

BEST AVAILABLE COPY